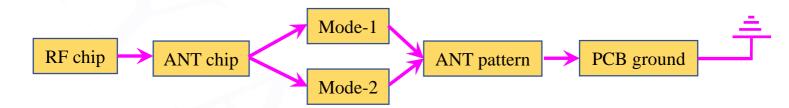
P/N: HY160808 SRF09

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Features:

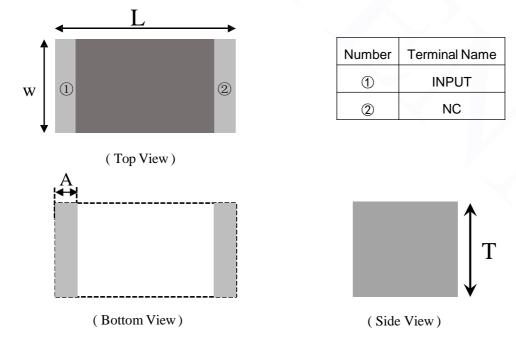
- 1. Surface mounted element with a small dimension of $1.6 \times 0.8 \times 0.8$ mm meet future miniaturization trend.
- 2. Embedded and LTCC (low temperature co-fired ceramic) technology is able to integrate with system design as well as beatifying the housing of final product.
- 3. Miniaturization, wideband, high stability, low ESR, and low tolerance.
- 4. Dual-band resonances in the dominant and harmonic modes enables multiband operations.
- 5. Novel ground-radiation technique enables radiation from both the antenna and the ground plane.



✓ Applications:

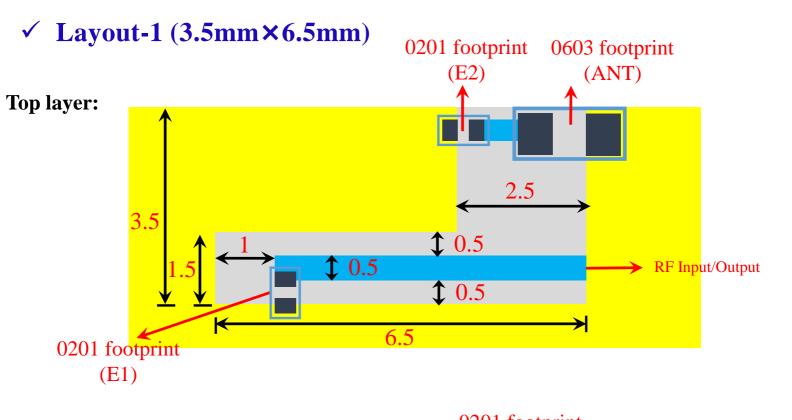
- 1. Bluetooth
- 2. Dual-band WLAN
- 3. ISM and UWB

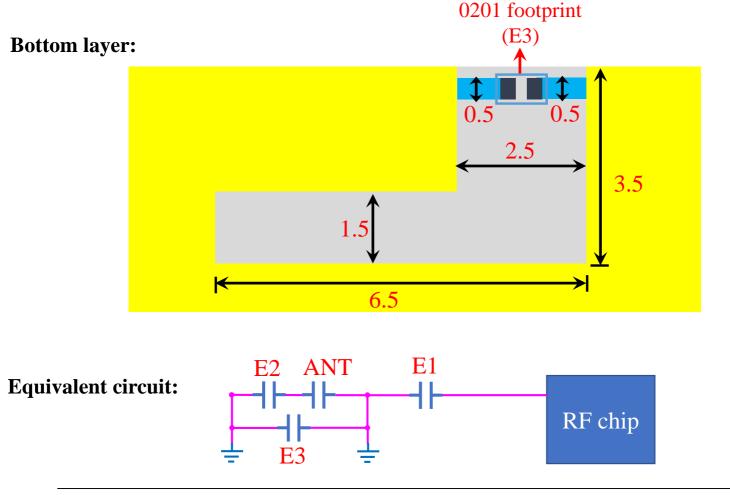
✓ Dimensions (Unit: mm)

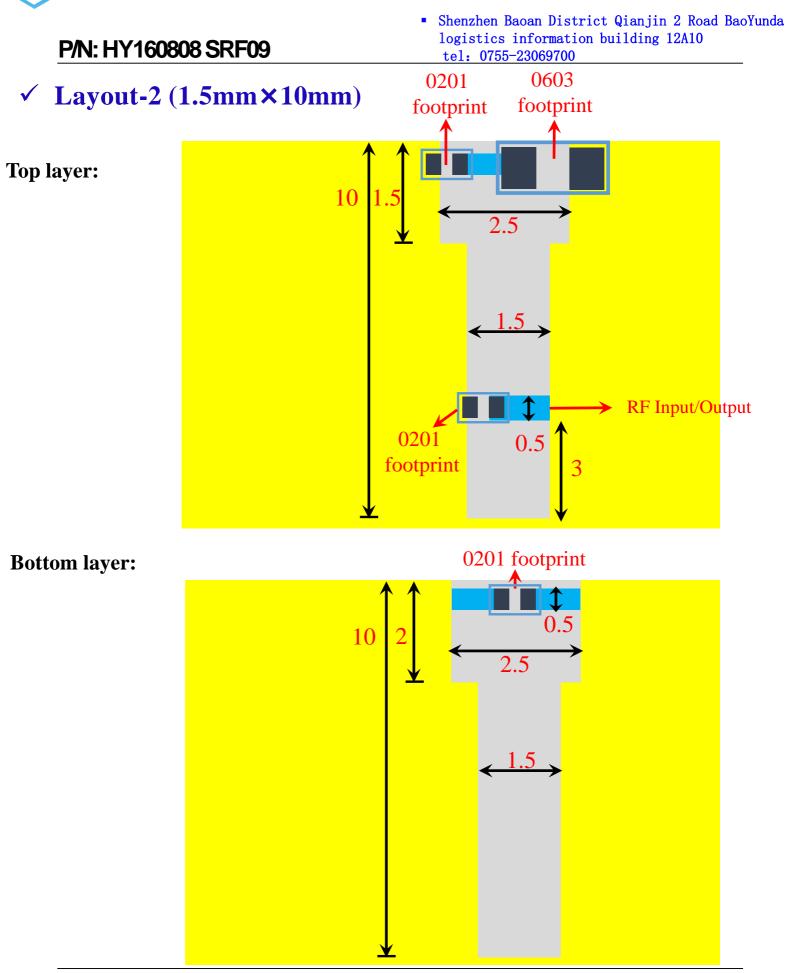


Symbols	L	W	Т	А	
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.80 ± 0.20	0.30 ± 0.10	

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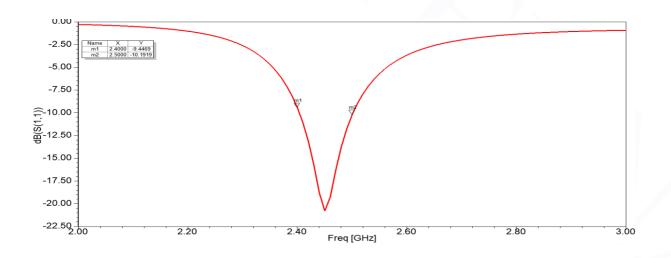


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✓ Electrical Characteristics:

	Feature	Specification		
1	Central frequency	2.45GHz		
2	Bandwidth	>150MHz		
3	Peak gain	2.78 dBi		
4	VSWR	<2		
5	Polarization	Linear		
6	Azimuth beamwidth	Omnidirectional		
7	Impedance	50 Ω		

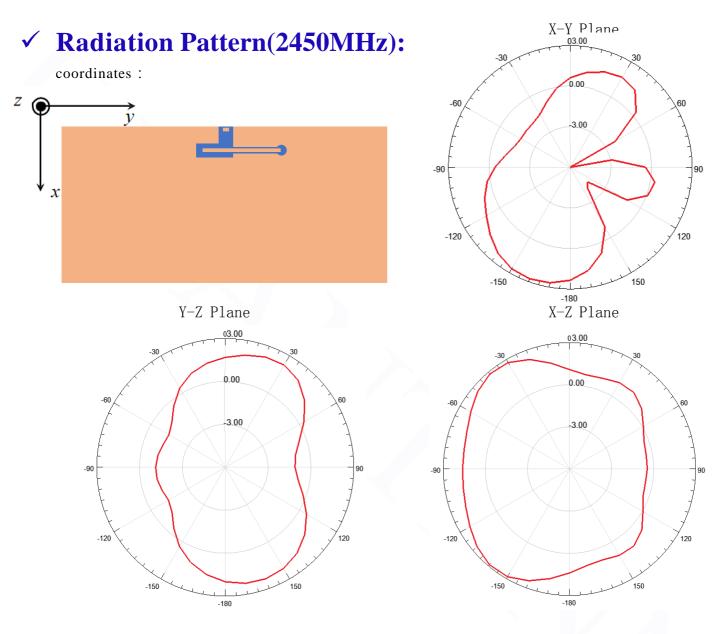
Characteristic Curves:



深圳汉阳天线设计有限公司 Shenzhen Hanyang Antenna Design Co. Ltd.

- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
- 青岛市崂山区松岭路399号海信产业园A1号楼606
 - 电话: 0755-23069700 传真: 0755-23069700

P/N: HY160808 SRF07, HY160808 SRF08, HY160808 SRF09



✓ Radiation Performance:

Frequency	2400MHz	2450MHz	2500MHz
Avg. gain	-1.92	-1.35	-1.56
Peak gain	1.79	2.78	2.66
Efficiency	74.55	80.25	76.98

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✓ Dependability Test

Test Temperature $25^{\circ}C \pm 5^{\circ}C$ Operating Temperature $-25^{\circ}C \sim +125^{\circ}C$ Temperature $5\sim 40^{\circ}C$ Relative Humidity $20\sim 70\%$

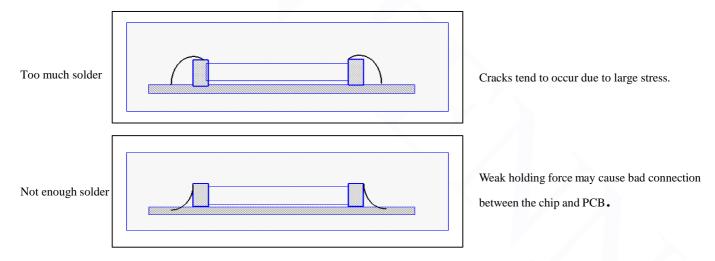
✓ Moisture Proof

Temperature: 40±2°C Humidity: 90~95%RH Duration: 500h Recovery conditions: Room temperature Recovery Time: 24h (Class1) or 48h (Class2)

Solderability

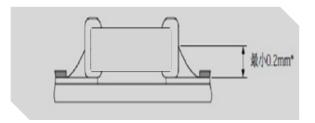
At least 95% of the terminal electrode is covered by new solder. Preheating conditions:80 to 120° C; $10 \sim 30$ s. Solder Temperature: $235 \pm 5^{\circ}$ C Duration: 2 ± 0.5 s, Solder Temperature: $245 \pm 5^{\circ}$ C Duration: 2 ± 0.5 s

Optimum Solder Amount for Reflow Soldering

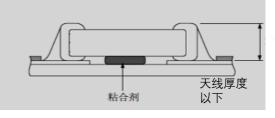


✓ Recommended Soldering Amounts

The optimal solder fillet amounts for re-flow soldering



The optimal solder fillet amounts for wave soldering



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Temperature Cycle Test

 $10\pm1S$ Applied Force: 5N Duration: $10\pm1S$ Preheating conditions: up-category temperature, 1h Recovery time: $24\pm1h$ Initial Measurement Cycling Times: 5 times, 1 cycle, 4 steps:

Stage	Temperature(°C)	Time (minutes)
Step 1	Lower temperature limit (NPOX7R/X75/X65/X5R-55) Y5V:25 Z5U:10	30
Step 2	normal atmospheric temperature(+20)	2-3
Step 3	Upper line temperature $\binom{NPO'X7R/X7S:+125}{Y5V/Z5U/X5R:+85 X6S:+105}$	30
Step 4	normal atmospheric temperature(+20)	2-3

Resistance to Soldering Heat

Preheating 80 to 120° C; $10 \sim 30$ s.SolderTemperature: $235\pm5^{\circ}$ C; Duration: 2 ± 0.5 s; SolderTemperature: $245\pm5^{\circ}$ C Duration: 2 ± 0.5 s; Preheating 100 to 200° C; 10 ± 2 min.

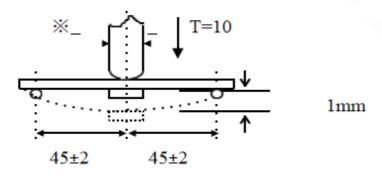
Solder Temperature: 265±5°C; Duration: 10±1s

Clean the capacitor with solvent and examine it with a 10X(min.) microscope.

Recovery Time: 24±2h

Recovery condition: Room temperature

✓ Resistance to Flexure of Substrate



Test Board: Al₂O₃ or PCB Warp: 1mm Speed: 0.5mm/sec. Unit: mm

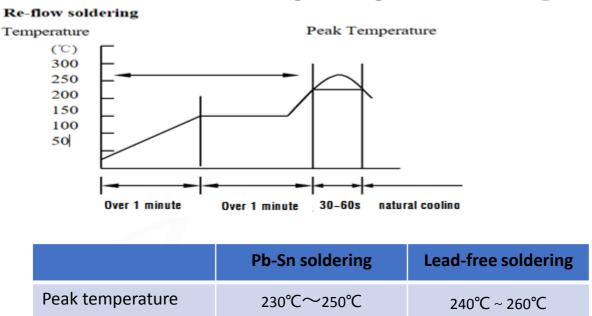
The measurement should be made with the board in the bending position.

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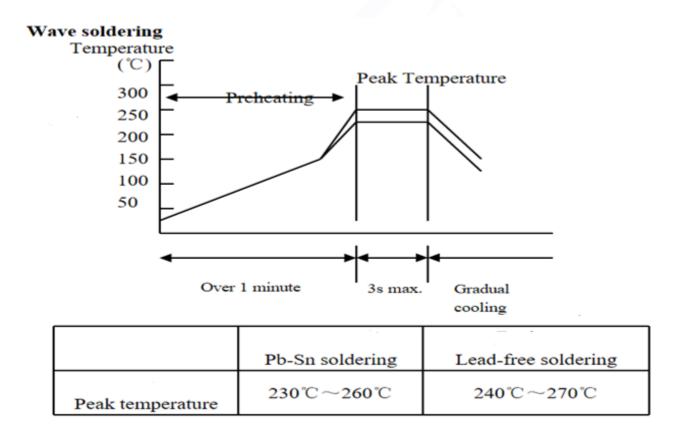
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The temperature profile for soldering

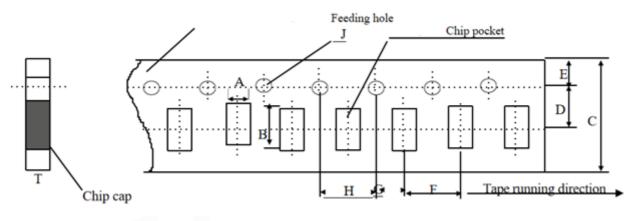
While in preheating, please keep the temperature difference between soldering temperature and surface temperature of chips as: T \leq 150°C.



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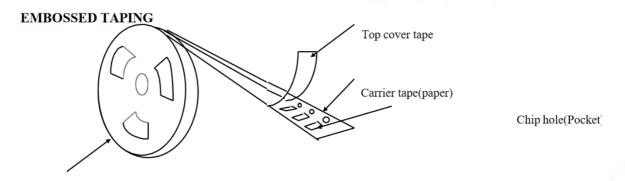
✓ Dimensions of paper taping



Unit: mm

Code	А	В	С	D*	E	F	G*	Н	J	Т
Cino	1.10	1.90	8.00	3.50	1.75	4.00	2.00	4.00	1.50	1.10
Size	±0.10	±0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.10	-0/+0.10	Max

Reel (4000 pcs/Reel)



Polystyrene reel

✓ Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition). Temperature: $5\sim40^{\circ}$ C /Relative Humidity: $20\sim70\%$